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|---|----|--|--------------|-----------------|--------------------------------|----------|----------------------------|----|
| U.S. Department of Commerce, Patent and Trademark Office  |    |  |              |                 | Atty Docket No.                |          | Serial No.                 |    |
|   |    |  |              |                 | CIS0203US                      |          | Unassigned                 |    |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT   |    |  |              |                 | Applicants                     |          |                            |    |
| (Use several sheets if necessary)   |    |  |              |                 | Gopakumar Parameswaran, et al. |          |                            |    |
|   |    |  |              |                 | Filing Date                    |          | Group                      |    |
|   |    |  |              |                 | Herewith                       |          | Unassigned                 |    |
| U.S. Patent Documents   |    |  |              |                 |                                |          |                            |    |
| *Examiner Initial   |    | Document Number  | Date         | Name            | Class                          | Subclass | Filing Date If Appropriate |    |
|   | AA |  |              |                 |                                |          |                            |    |
|   | AB |  |              |                 |                                |          |                            |    |
|   | AC |  |              |                 |                                |          |                            |    |
|   | AD |  |              |                 |                                |          |                            |    |
|   | AE |  |              |                 |                                |          |                            |    |
|   | AF |  |              |                 |                                |          |                            |    |
| Patent Application Publication  |    |  |              |                 |                                |          |                            |    |
|   |    | Publication Number   | Pub. Date    | Name            | Class                          | Subclass | Filing Date If Appropriate |    |
|   | AG | 2003/0147375 A1  | Aug. 7, 2003 | Goergen, et al. | 370                            | 351      |                            |    |
| Foreign Patent Documents  |    |  |              |                 |                                |          |                            |    |
|   |    | Document   | Date         | Country         | Class                          | Subclass | Translation                |    |
|   |    |  |              |                 |                                |          | Yes                        | No |
|   | AH |  |              |                 |                                |          |                            |    |
|   | AI |  |              |                 |                                |          |                            |    |
|   | AJ |  |              |                 |                                |          |                            |    |
|   | AK |  |              |                 |                                |          |                            |    |
|   | AL |  |              |                 |                                |          |                            |    |
| OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)  |    |  |              |                 |                                |          |                            |    |
|   | AM | GREEN, Lynne, pcb-update, "Crosstalk for Printed Circuit Board Designers," <a href="http://asp.pcb-update.com/data/newsletter/pcb-update-news-vol-2.pdf">http://asp.pcb-update.com/data/newsletter/pcb-update-news-vol-2.pdf</a> , January 2001, pp. 1-12.   |              |                 |                                |          |                            |    |
|   | AN | Cadence Design Systems, Inc., "Inside Differential Signals," Cadence Community Education Series – December 2001, <a href="http://www.specctrarequest.com/Downloads/InsideDiffSigals_Green.qxd.pdf">http://www.specctrarequest.com/Downloads/InsideDiffSigals_Green.qxd.pdf</a> , pp. 1-4.              |              |                 |                                |          |                            |    |
|   | AO | BELOPOLSKY, Yakov and ELLIS, John, FCI Electronics, Inc., "Modular Connectors For High Speed Differential Signal Transmission," <a href="http://www.fciconnect.com/products/technical_01_06.asp">http://www.fciconnect.com/products/technical_01_06.asp</a> , pp. 1-12 (printed on November 19, 2003). |              |                 |                                |          |                            |    |
|   | AP |  |              |                 |                                |          |                            |    |
| Examiner  |    | Date Considered 3-17-06  |              |                 |                                |          |                            |    |
| *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant. |    |  |              |                 |                                |          |                            |    |